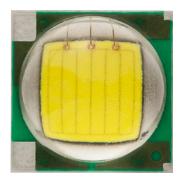


Cree® XLamp® XM-L LEDs



PRODUCT DESCRIPTION

The XLamp XM-L LED is the industry's highest performance, single-die white lighting-class LED. The XLamp XM-L is 20% more efficient than the XLamp XP-G at the same current, and can deliver 1000 lumens with 100 lumens per watt efficacy. The XLamp XM-L LED offers Cree's industry-leading features: wide viewing angle, symmetrical package, unlimited floor life and electrically neutral thermal path.

XLamp XM-L LEDs can enable LED light into new applications that require tens of thousands of lumens, such as high bay and high-output area lighting. The XM-L is also the ideal choice for lighting applications where high light output and maximum efficacy are required, such as LED light bulbs, outdoor lighting, portable lighting, indoor lighting and solar-powered lighting.

FEATURES

- Maximum drive current: 3000 mA
- Low thermal resistance:
 2.5 °C/W
- Maximum junction temperature: 150 °C
- Viewing angle: 125°
- Available in cool white, 80-CRI minimum neutral white and 80-CRI, 85-CRI and 90-CRI warm white
- ANSI-compatible chromaticity bins
- Unlimited floor life at
 ≤ 30 °C/85% RH
- Reflow solderable -JEDEC J-STD-020C
- Electrically neutral thermal path
- RoHS- and REACh-compliant
- UL-recognized component (E349212)



TABLE OF CONTENTS

Flux Characteristics 2
Characteristics 3
Relative Spectral Power
Distribution 3
Relative Flux vs. Junction
Temperature 4
Electrical Characteristics 4
Thermal Design5
Relative Flux vs. Current 5
Relative Chromaticity vs. Current
(Cool White)6
Relative Chromaticity vs.
Temperature (Cool White)6
Relative Chromaticity vs. Current
(Warm White)7
Relative Chromaticity vs.
Temperature (Warm White) 7
Typical Spatial Distribution 8
Reflow Soldering Characteristics 9
Notes10
Mechanical Dimensions11
Tape and Reel12
Packaging13



FLUX CHARACTERISTICS (T₁ = 25 °C)

The following table provides several base order codes for XLamp XM-L LEDs. It is important to note that the base order codes listed here are a subset of the total available order codes for the product family. For more order codes, as well as a complete description of the order-code nomenclature, please consult the XLamp XM-L Binning and Labeling document.

Color	CCT Range		Base Order Codes Min. Luminous Flux @ 700 mA		Calculated Minimum Luminous Flux (lm)*			Order Code	
	Min.	Max. Group Flux (lm) 1000 mA 1500 mA 2000 m		2000 mA					
Cool White		8300 K	T5	260	360	511	643	XMLAWT-00-0000-0000T5051	
	5000 K		T6	280	388	551	692	XMLAWT-00-0000-0000T6051	
			U2	300 416 590 742	742	XMLAWT-00-0000-0000U2051			
Neutral White 3700 K	2700 V	5000 K	T4	240	332	472	593	XMLAWT-00-0000-000LT40E4	
	3700 K		T5	260	360	511	643	XMLAWT-00-0000-000LT50E4	
80-CRI White 260	2600 K	4300 K	T2	200	277	393	494	XMLAWT-00-0000-000HT20E7	
80-CRI WIIILE	2000 K		Т3	220	305	433	544	XMLAWT-00-0000-000HT30F7	
Warm White 2600 K	2600 K	3700 K	T2	200	277	393	494	XMLAWT-00-0000-000LT20E7	
warm write	2000 K	3700 K	T3	220	305	433	544	XMLAWT-00-0000-000LT30F7	
85-CRI White 2600 K		3200 K	S4	164	227	323	406	XMLAWT-00-0000-000PS40E7	
	2600 K		S5	172	238	338	425	XMLAWT-00-0000-000PS50E7	
			S6	182	252	358	450	XMLAWT-00-0000-000PS60E7	
90-CRI White	2600 K	3200 K	S4	164	227	323	406	XMLAWT-00-0000-000US40E7	
			S5	172	238	338	425	XMLAWT-00-0000-000US50E7	
			S6	182	252	358	450	XMLAWT-00-0000-000US60E7	

Notes:

- Cree maintains a tolerance of \pm 7% on flux and power measurements, \pm 0.005 on chromaticity (CCx, CCy) measurements and \pm 2 on CRI measurements.
- Typical CRI for Cool White (5000 K 8300 K CCT) is 65.
- Typical CRI for Neutral White (3700 K 5000 K CCT) is 75.
- Typical CRI for Warm White (2600 K 3700 K CCT) is 80.
- Minimum CRI for 80-CRI White is 80.
- Minimum CRI for 85-CRI White is 85.
- · Minimum CRI for 90-CRI White is 90.

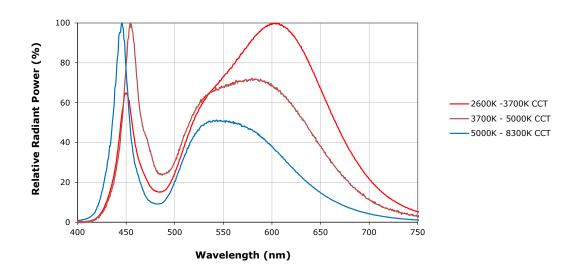
Calculated flux values are for reference only.



CHARACTERISTICS

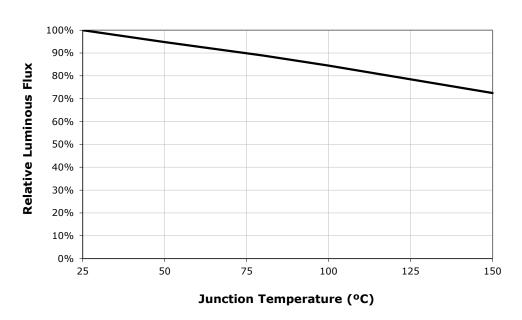
Characteristics	Unit	Minimum	Typical	Maximum
Thermal resistance, junction to solder point	°C/W		2.5	
Viewing angle (FWHM)	degrees		125	
Temperature coefficient of voltage	mV/°C		-2.1	
ESD classification (HBM per Mil-Std-883D)			Class 2	
DC forward current	mA			3000
Reverse voltage	V			5
Forward voltage (@ 700 mA)	V		2.9	3.5
Forward voltage (@ 1500 mA)	V		3.1	
Forward voltage (@ 3000 mA)	V		3.35	
LED junction temperature	°C			150

RELATIVE SPECTRAL POWER DISTRIBUTION

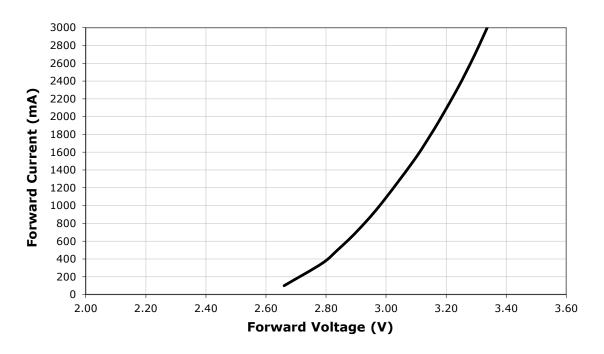




RELATIVE FLUX VS. JUNCTION TEMPERATURE ($I_F = 700 \text{ mA}$)



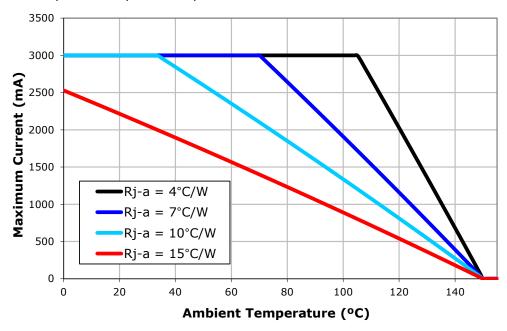
ELECTRICAL CHARACTERISTICS $(T_1 = 25 \text{ °C})$



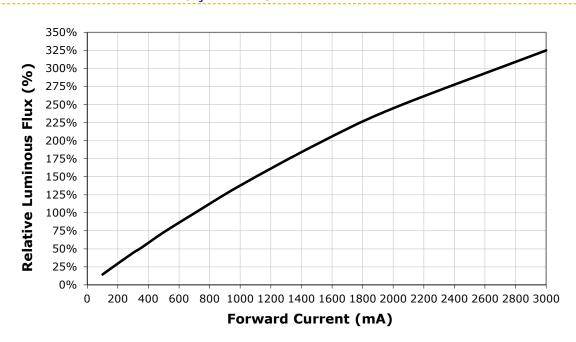


THERMAL DESIGN

The maximum forward current is determined by the thermal resistance between the LED junction and ambient. It is crucial for the end product to be designed in a manner that minimizes the thermal resistance from the solder point to ambient in order to optimize lamp life and optical characteristics.

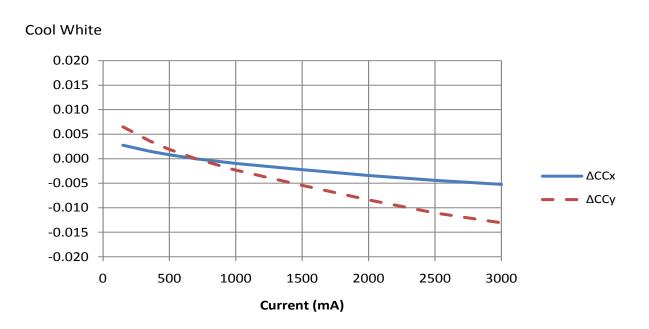


RELATIVE FLUX VS. CURRENT (T, = 25 °C)

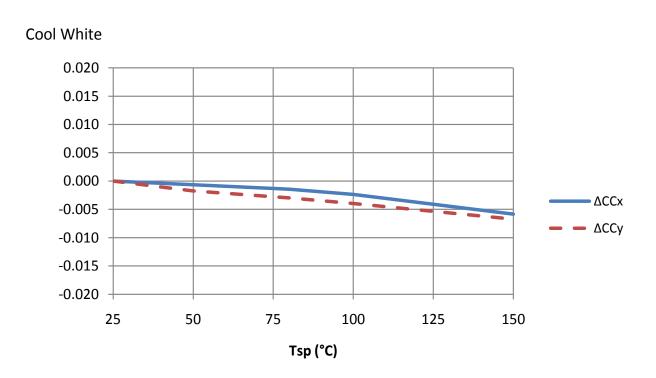




RELATIVE CHROMATICITY VS. CURRENT (COOL WHITE)

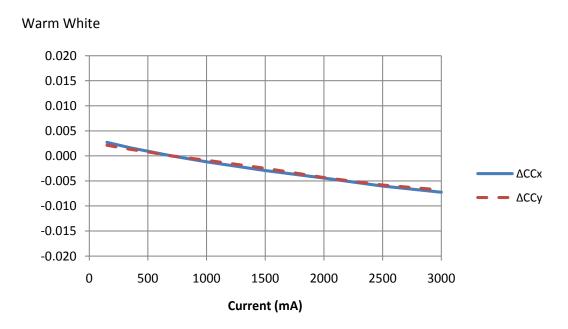


RELATIVE CHROMATICITY VS. TEMPERATURE (COOL WHITE)



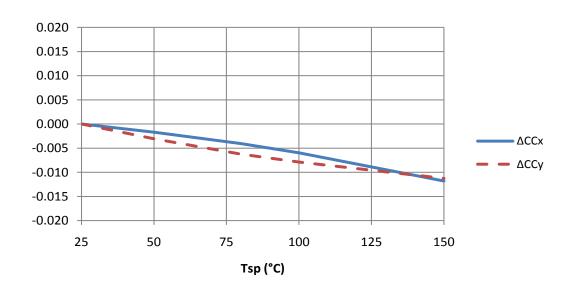


RELATIVE CHROMATICITY VS. CURRENT (WARM WHITE)



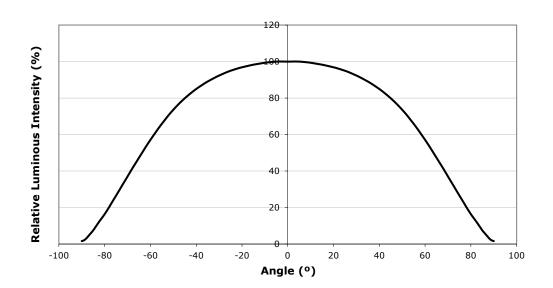
RELATIVE CHROMATICITY VS. TEMPERATURE (WARM WHITE)

Warm White





TYPICAL SPATIAL DISTRIBUTION

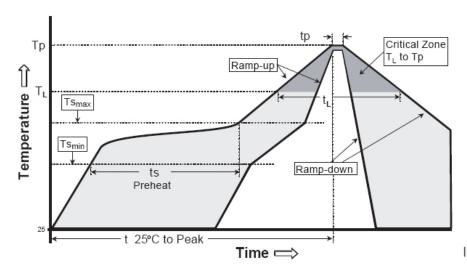




REFLOW SOLDERING CHARACTERISTICS

In testing, Cree has found XLamp XM-L LEDs to be compatible with JEDEC J-STD-020C, using the parameters listed below. As a general guideline, Cree recommends that users follow the recommended soldering profile provided by the manufacturer of solder paste used.

Note that this general guideline may not apply to all PCB designs and configurations of reflow soldering equipment.



IPC/JEDEC J-STD-020C

Profile Feature	Lead-Based Solder	Lead-Free Solder
Average Ramp-Up Rate (Ts _{max} to Tp)	3 °C/second max.	3 °C/second max.
Preheat: Temperature Min (Ts _{min})	100 °C	150 °C
Preheat: Temperature Max (Ts _{max})	150 °C	200 °C
Preheat: Time (ts _{min} to ts _{max})	60-120 seconds	60-180 seconds
Time Maintained Above: Temperature (T _L)	183 °C	217 °C
Time Maintained Above: Time (t _L)	60-150 seconds	60-150 seconds
Peak/Classification Temperature (Tp)	215 °C	260 °C
Time Within 5 °C of Actual Peak Temperature (tp)	10-30 seconds	20-40 seconds
Ramp-Down Rate	6 °C/second max.	6 °C/second max.
Time 25 °C to Peak Temperature	6 minutes max.	8 minutes max.

Note: All temperatures refer to the topside of the package, measured on the package body surface.



NOTES

Lumen Maintenance Projections

Cree now uses standardized IES LM-80-08 and TM-21-11 methods for collecting long-term data and extrapolating LED lumen maintenance. For information on the specific LM-80 data sets available for this LED, refer to the public LM-80 results document at www.cree.com/xlamp_app_notes/LM80_results.

Please read the XLamp Long-Term Lumen Maintenance application note at www.cree.com/xlamp_app_notes/lumen_maintenance for more details on Cree's lumen maintenance testing and forecasting. Please read the XLamp Thermal Management application note at www.cree.com/xlamp_app_notes/thermal_management for details on how thermal design, ambient temperature, and drive current affect the LED junction temperature.

Moisture Sensitivity

In testing, Cree has found XLamp XM-L LEDs to have unlimited floor life in conditions ≤30 °C/85% relative humidity (RH). Moisture testing included a 168-hour soak at 85 °C/85% RH followed by 3 reflow cycles, with visual and electrical inspections at each stage.

Cree recommends keeping XLamp LEDs in their sealed moisture-barrier packaging until immediately prior to use. Cree also recommends returning any unused LEDS to the resealable moisture-barrier bag and closing the bag immediately after use.

RoHS Compliance

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as amended through June 8, 2011. RoHS Declarations for this product can be obtain from your Cree representative or obtained from the Product Ecology section of www.cree.com.

REACh Compliance

REACh substances of high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notices of their intent to frequently revise the SVHC listing for the foreseeable future, please contact a Cree representative to insure you get the most up-to-date REACh Declaration. Historical REACh banned substance information (substances restricted or banned in the EU prior to 2010) is also available upon request.

UL Recognized Component

Level 4 enclosure consideration. The LED package or a portion thereof has been investigated as a fire and electrical enclosure per ANSI/UL 8750.

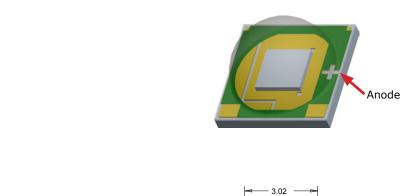
Vision Advisory Claim

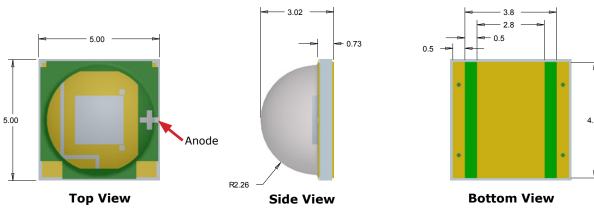
WARNING: Do not look at exposed lamp in operation. Eye injury can result. See the LED Eye Safety aplication note at www.cree.com/xlamp_app_notes/led_eye_safety.

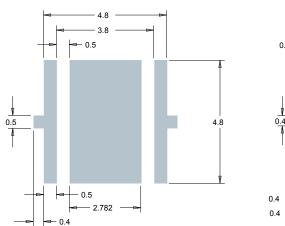


MECHANICAL DIMENSIONS

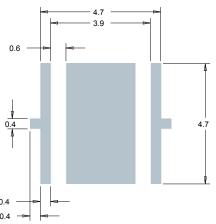
All measurements are $\pm .13$ mm unless otherwise indicated.









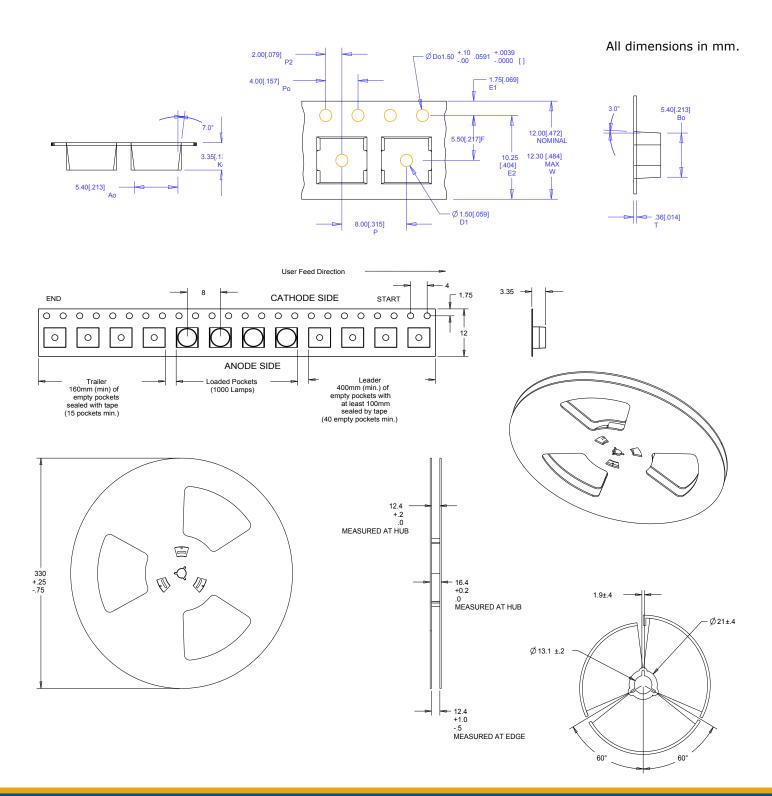


Recommended Stencil Pattern (Shaded Area Is Open)



TAPE AND REEL

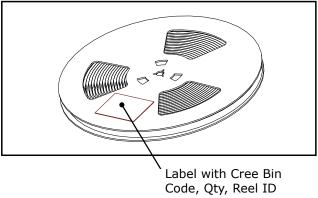
All Cree carrier tapes conform to EIA-481D, Automated Component Handling Systems Standard.



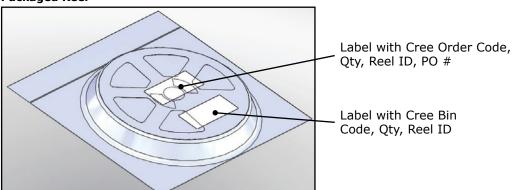


PACKAGING

Unpackaged Reel



Packaged Reel



Boxed Reel

